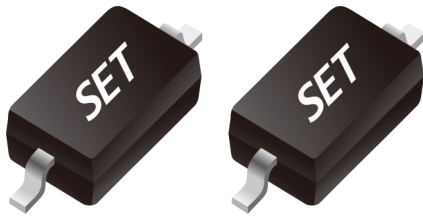


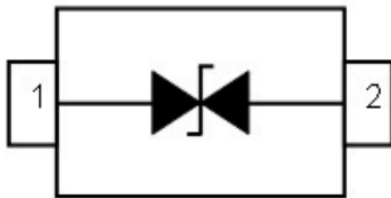
# ESD Protection Diodes

Low Capacitance Bi-directional ESD and Transient Voltage Protection

SD0525D32L SOD323



## Pinout and Functional Block Diagram



## Description

The SD0525D32L is designed to protect voltage sensitive components from ESD and transient voltage events. Excellent clamping capability, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium. Because of its small size, it is suited for use in cellular phones, portable devices, digital cameras, power supplies and many other portable applications where board space comes at a premium. Also because of its low capacitance, it is suited for use in high frequency designs such as USB 2.0 high speed, VGA, DVI, SDI and other high speed line applications. This device has been specifically designed to protect sensitive components which are connected to data and transmission lines from overvoltage caused by ESD (electrostatic discharge), and EFT (electrical fast transients).

## Applications

- High Speed Line :USB1.0/2.0, VGA, DVI, SDI,
- Serial and Parallel Ports
- Projection TV
- Notebooks, Desktops, and Servers
- Cell Phone Handsets and Accessories
- Portable Instrumentation
- Peripherals

## Features

- IEC61000-4-2 (ESD)  $\pm 30$  kV (Air),  $\pm 30$  kV (Contact)
- IEC61000-4-4 (EFT) 40 A (5 / 50 ns)
- Peak Power Dissipation: 400 W@8 / 20  $\mu$ s
- Low Clamping Voltage
- Low Leakage Current
- High Temperature to Reflow Soldering Guaranteed: 260  $^{\circ}$ C / 10 sec
- MSL1
- Flammability Rating: UL 94 V-0
- Halogen Free and RoHS Compliant

## Order Information

Type	Package	Marking Code	Delivery Form	Delivery Quantity
SD0525D32L	SOD323	5/9	7" T&R	3000 PCS

## Limiting Values

(T<sub>A</sub> = 25  $^{\circ}$ C, unless otherwise specified)

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>ESD</sub>	Electrostatic Discharge Voltage	IEC 61000-4-2; Contact Discharge	-	30	kV
		IEC 61000-4-2; Air Discharge	-	30	kV
P <sub>PP</sub>	Peak Pulse Power (8 / 20 $\mu$ s)	-	-	400	W
T <sub>A</sub>	Operating Temperature Range	-	-55	150	$^{\circ}$ C
T <sub>stg</sub>	Storage Temperature Range	-	-55	150	$^{\circ}$ C

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## Electrical Characteristics

( $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise specified)

Symbol	Parameter	Conditions	Min	Typ.	Max	Unit
$V_{RWM}$	Max. Reverse Working Voltage	$T_A = 25\text{ }^\circ\text{C}$	-	-	5.0	V
$V_{BR}$	Breakdown Voltage	$I_R = 1\text{ mA}; T_A = 25\text{ }^\circ\text{C}$	5.8	-	7.8	V
$I_R$	Reverse Leakage Current	$V_{RWM} = 5\text{ V}; T_A = 25\text{ }^\circ\text{C}$	-	-	1.0	$\mu\text{A}$
$V_C$	Clamping Voltage	$I_{PP}=1\text{ A}, t_p=8 / 20\text{ }\mu\text{s}$	-	-	9.8	V
		$I_{PP}=25\text{ A}, t_p=8 / 20\text{ }\mu\text{s}$	-	15	20	V
$C_J$	Junction Capacitance	$V_R = 0\text{ V}, f = 1\text{ MHz}$	-	-	60	pF

## Performance Curve for Reference

( $T_A=25\text{ }^\circ\text{C}$  unless otherwise noted)

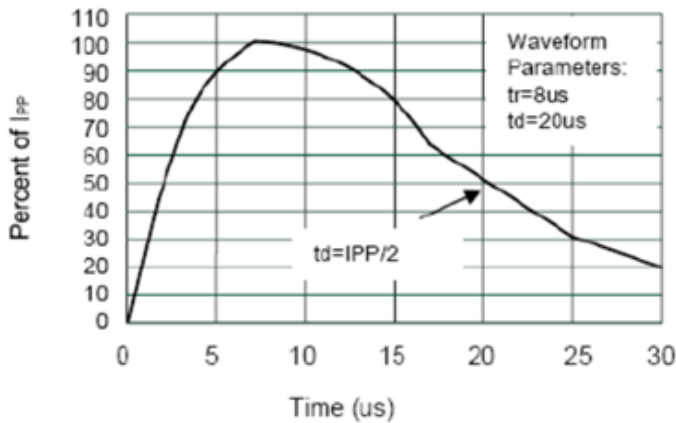


FIGURE 1  
Pulse Waveform

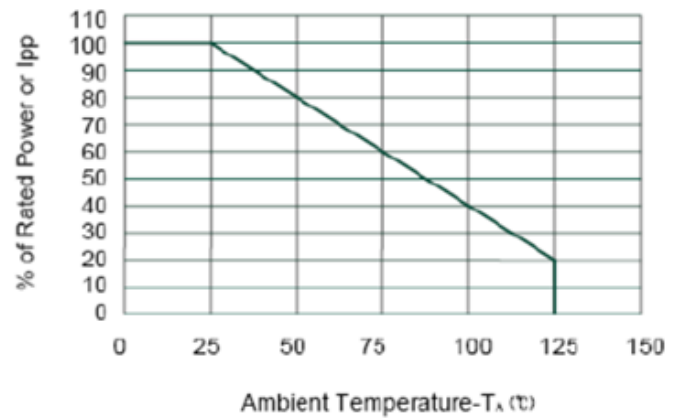


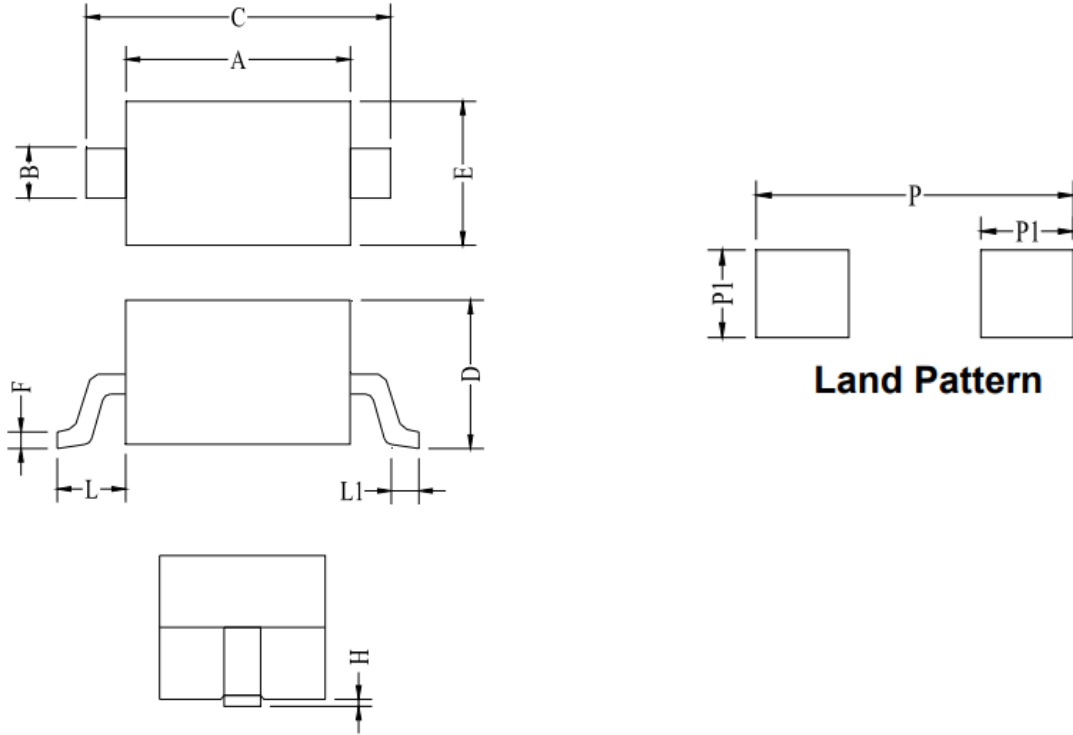
FIGURE 2  
Power Derating Curve

# ESD Protection Diodes

Low Capacitance Bi-directional ESD and Transient Voltage Protection

SD0525D32L SOD323

## Package Dimensions - SOD323



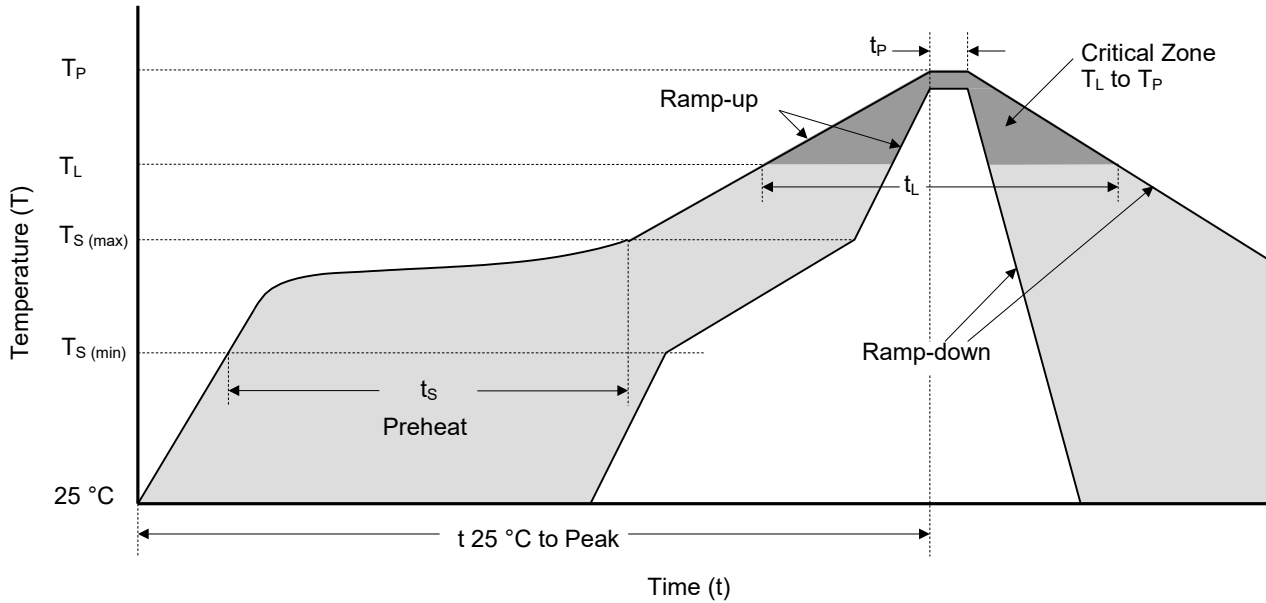
Symbol	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	1.60	1.80	0.063	0.071
B	0.25	0.40	0.010	0.016
C	2.30	2.80	0.091	0.110
D	0.80	1.10	0.031	0.043
E	1.20	1.40	0.047	0.055
F	0.08	0.18	0.003	0.007
L	0.475 Ref.		0.019 Ref.	
L1	0.25	0.40	0.010	0.016
H	0.00	0.14	0.000	0.006
P	3.00		0.118	
P1	0.80		0.031	

# ESD Protection Diodes

Low Capacitance Bi-directional ESD and Transient Voltage Protection

SD0525D32L SOD323

## Soldering Parameters



Reflowing Condition

Reflow Soldering Parameters		Lead-Free Assembly
Pre-heat	Temperature Min ( $T_{S (min)}$ )	150 °C
	Temperature Max ( $T_{S (max)}$ )	200 °C
	Time (min to max) ( $t_s$ )	60 ~ 120 seconds
Average Ramp Up Rate (Liquidus Temp ( $T_L$ ) to Peak)		3 °C / second max.
$T_S (max)$ to $T_L$ Ramp-up Rate		3 °C / second max.
Reflow	Temperature ( $T_L$ ) (Liquidus)	217 °C
	Time (min to max) ( $t_L$ )	60 ~ 150 seconds
Peak Temperature ( $T_P$ )		260 <sup>+0/-5</sup> °C
Time of within 5 °C of Actual Peak Temperature ( $t_p$ )		20 ~ 40 seconds
Ramp-down Rate		6 °C / second max.
Time from 25 °C to Peak Temperature		8 Minutes max.
Do Not Exceed		260 °C



# ATTENTION

## Usage

1. TVS must be operated in the specified ambient temp.
2. Do not clean the TVS with strong polar solvent such as ketone, esters, benzene and halogenated hydrocarbon, to avoid damaging the encapsulating layer.
3. Please do not apply severe vibration, shock or pressure to TVS, to avoid element cracking.

## Replacement

1. If TVS is visually damaged, please replace it.
2. TVS is a non-repairable product. For safety sake, please use equivalent TVS for replacement.

## Storage

1. Storage Temp. Range: (-55 to 150) °C.
2. Do not store the TVS at the high temp., high humidity or corrosive gas environment, to avoid influencing the solder-ability of the lead wires. The product shall be used up within 1 year after receiving the goods.

## Environmental Conditions

1. TVS should not be exposed to the open air, nor direct sunshine.
2. TVS should avoid rain, water vapor or other condition of high temp. and high humidity.
3. TVS should avoid sand dust, salt mist, or other harmful gases.

## Max. Typical Capacitance of TVS

1. The typical capacitance of TVS is listed in the specifications. Designers may refer to it when designing TVS in High frequency circuit.

## Installation Mechanical Stress

1. Do not knock TVS when installing, to avoid mechanical damage.
2. Please do not apply severe vibration, shock or pressure to TVS, to avoid surface resin or element cracking.